



# SPN55T20

## N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPN55T20 is the N-Channel enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

### FEATURES

- ◆ 200V/42A,  $R_{DS(ON)}=32m\Omega@V_{GS}=10V$
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-220-3L/TO-252-2L/PPAK5x6-8L package design

### APPLICATIONS

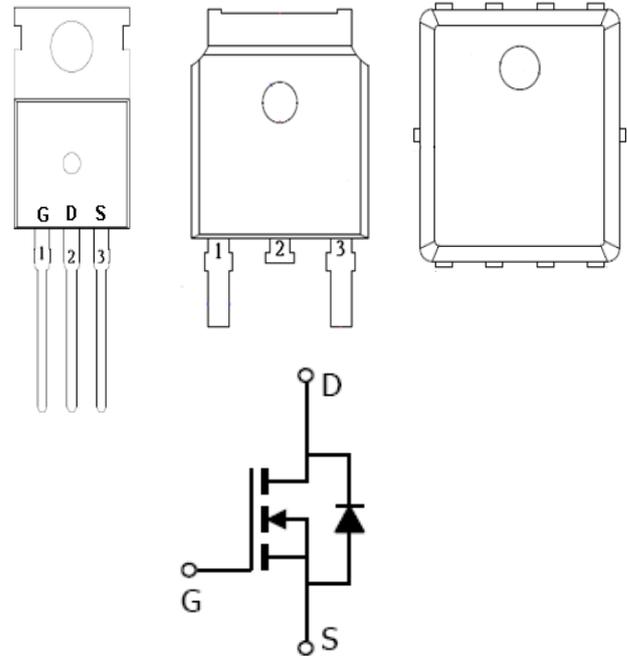
- DC/DC Converter
- Load Switch
- Synchronous Buck Converter
- SMPS Secondary Side Synchronous Rectifier
- Power Tool
- Motor Control

### PIN CONFIGURATION(PPAK5x6-8L)

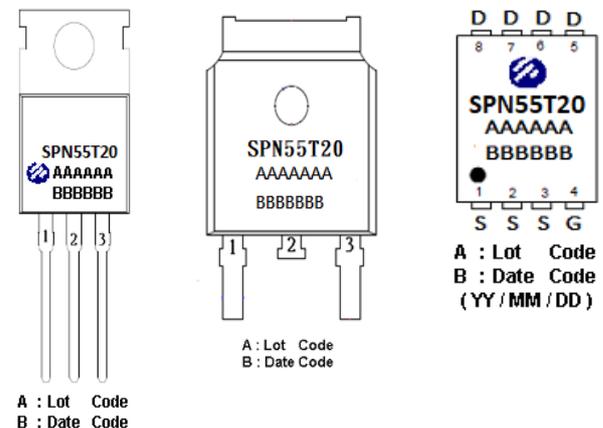
TO-220-3L

TO-252-2L

PPAK5x6-8L



### PART MARKING





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### PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

### PPAK5x6 PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPN55T20T220TGB	TO-220-3L	SPN55T20
SPN55T20T252RGB	TO-252-2L	SPN55T20
SPN55T20DN8RGB	PPAK5x6-8L	SPN55T20

- ※ SPN55T20T220TGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN55T20T252RGB : Tape Reel ; Pb – Free ; Halogen – Free
- ※ SPN55T20DN8RGB : 13” Tape Reel ; Pb – Free ; Halogen – Free



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### ABSOLUTE MAXIMUM RATINGS

( $T_A=25^{\circ}\text{C}$  Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	$V_{DSS}$	200	V
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	V
Continuous Drain Current(Silicon Limited)	$I_D$	$T_C=25^{\circ}\text{C}$ 42	A
		$T_C=100^{\circ}\text{C}$ 26	
Pulsed Drain Current	$I_{DM}$	140	A
Avalanche Energy, Single Pulse ( $L=0.4\text{mH}, T_C=25^{\circ}\text{C}$ )	$E_{AS}$	180	mJ
Power Dissipation (TO-220)	$P_D$	104	W
Power Dissipation (TO-252)		$T_C=25^{\circ}\text{C}$ 93	
Power Dissipation (PPAK5x6)		83	
Operating Junction Temperature	$T_J$	-55/150	$^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	-55/150	$^{\circ}\text{C}$
Thermal Resistance-Junction to Case (TO-220)	$R_{\theta JC}$	0.85	$^{\circ}\text{C}/\text{W}$
Thermal Resistance-Junction to Case (TO-252)	$R_{\theta JC}$	1.35	$^{\circ}\text{C}/\text{W}$
Thermal Resistance-Junction to Case (PPAK5x6)	$R_{\theta JC}$	1.5	$^{\circ}\text{C}/\text{W}$
Thermal Resistance-Junction to Ambient (TO-220)	$R_{\theta JA}$	60	$^{\circ}\text{C}/\text{W}$
Thermal Resistance-Junction to Ambient (TO-252)	$R_{\theta JA}$	50	$^{\circ}\text{C}/\text{W}$
Thermal Resistance-Junction to Ambient (PPAK5x6)	$R_{\theta JA}$	50	$^{\circ}\text{C}/\text{W}$



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### ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

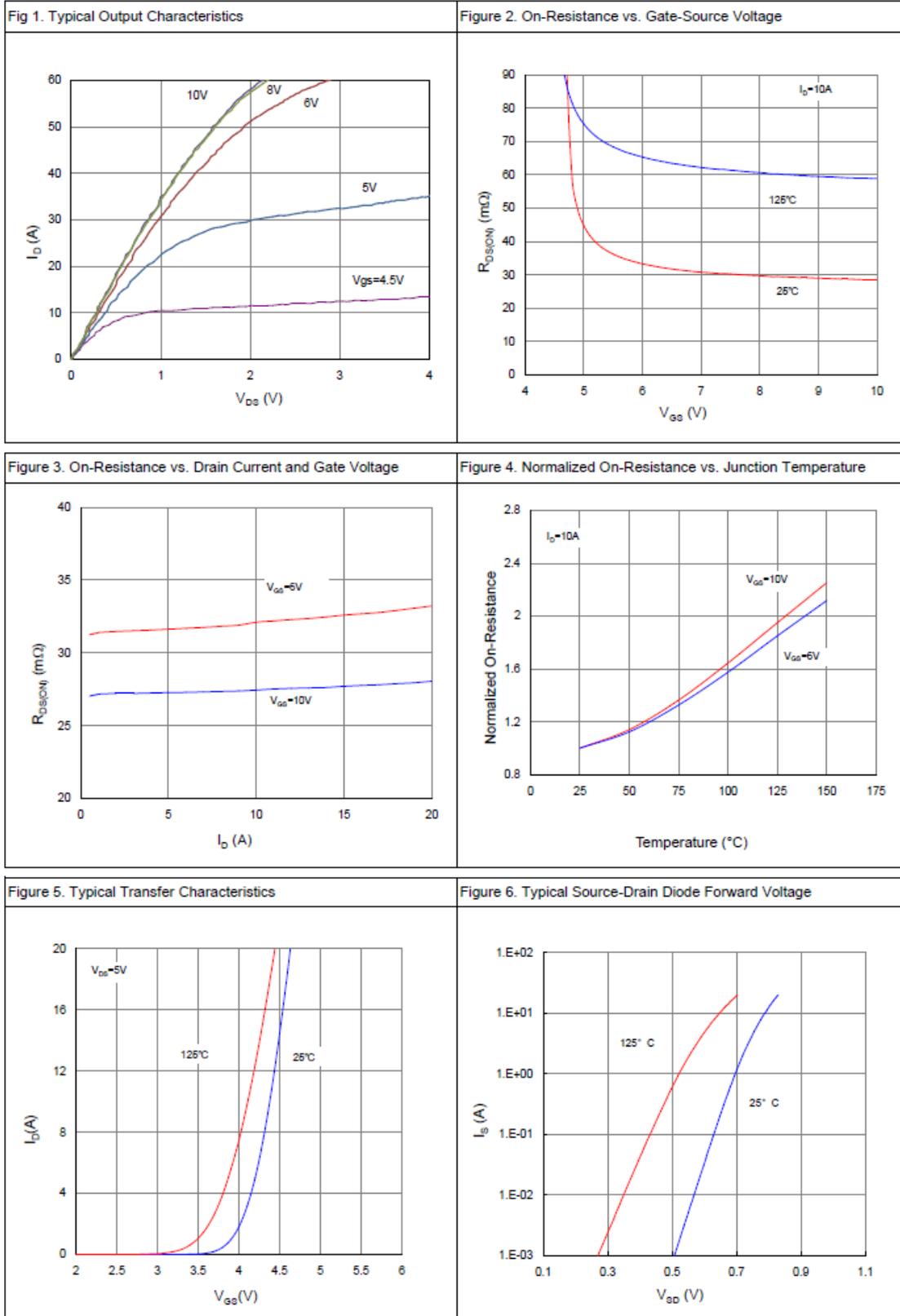
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	200			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	3	4	V
Gate Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=160V, V_{GS}=0V$ $T_J=25^\circ C$			1	uA
		$V_{DS}=160V, V_{GS}=0V$ $T_J=100^\circ C$			100	
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=10A$		28	32	mΩ
Transconductance	$g_{fs}$	$V_{DS}=5V, I_D=10A$		31		S
Gate Resistance	$R_G$	$V_{GS}=0V, V_{DS}=\text{Open},$ $f=1\text{MHz}$		4.6		Ω
Diode Forward Voltage	$V_{SD}$	$I_S=10A, V_{GS}=0V$		0.9	1.2	V
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=100V, V_{GS}=10V$ $I_D=10A$		19		nC
Gate-Source Charge	$Q_{gs}$			7		
Gate-Drain Charge	$Q_{gd}$			2		
Input Capacitance	$C_{iss}$	$V_{DS}=100V, V_{GS}=0V$ $f=1\text{MHz}$		1598		pF
Output Capacitance	$C_{oss}$			124		
Reverse Transfer Capacitance	$C_{rss}$			7.5		
Turn-On Time	$t_{d(on)}$	$V_{DD}=100V,$ $I_D=10A, V_{GS}=10V$ $R_G=10\Omega$		12		nS
	$t_r$			17		
Turn-Off Time	$t_{d(off)}$			23		
	$t_f$			10		
<b>Diode</b>						
Diode Forward Voltage	$V_{SD}$	$I_S=10A, V_{GS}=0V$		0.9	1.2	V
Reverse Recovery Time	$t_{rr}$	$V_R=100V, I_F=10A,$ $dI_F/dt=100A/\mu S$		90		nS
Reverse Recovery Charge	$Q_{rr}$			305		nC



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### TYPICAL CHARACTERISTICS

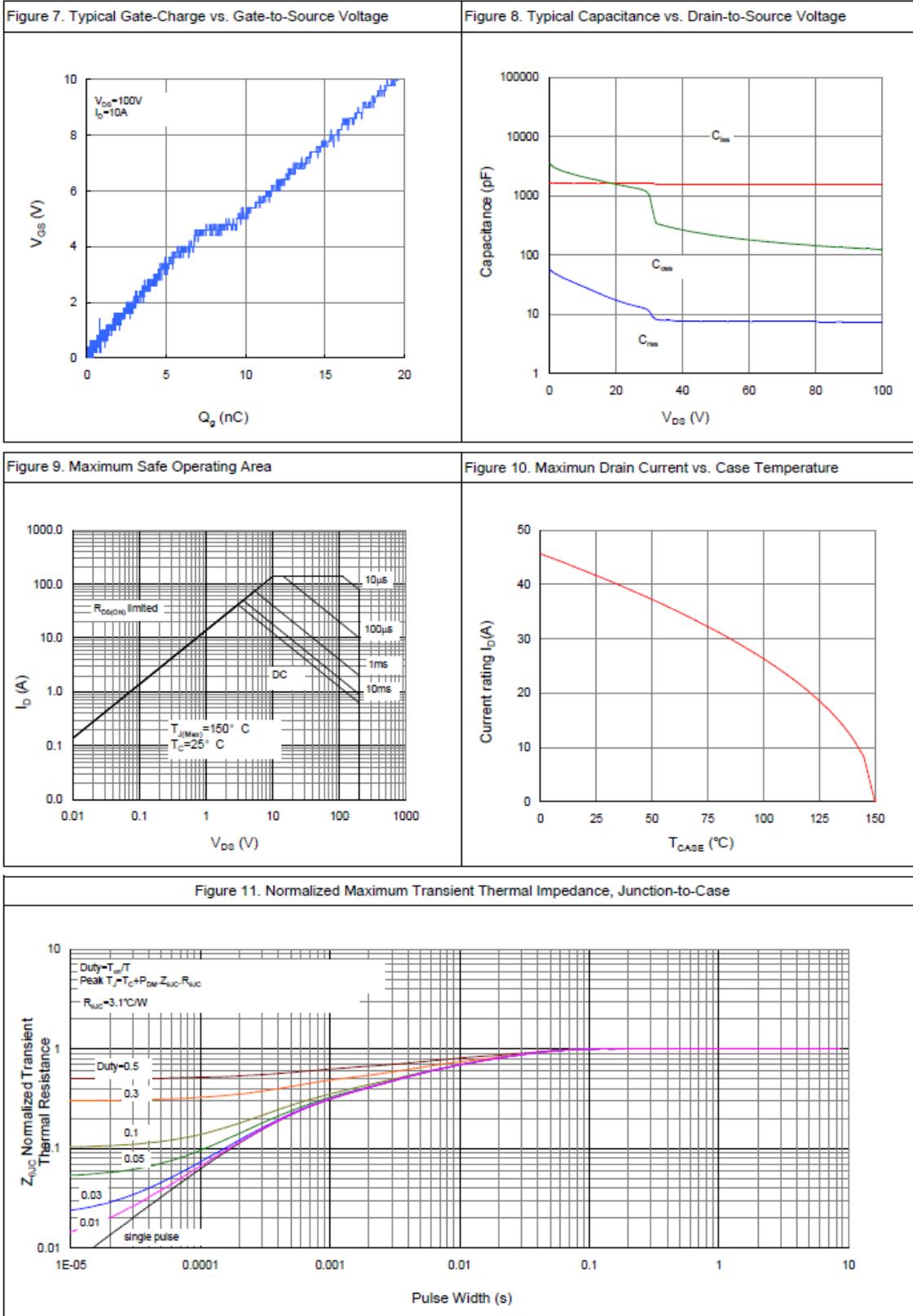




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### TYPICAL CHARACTERISTICS





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